## Silicon N Channel Power MOS FET High Speed Power Switching

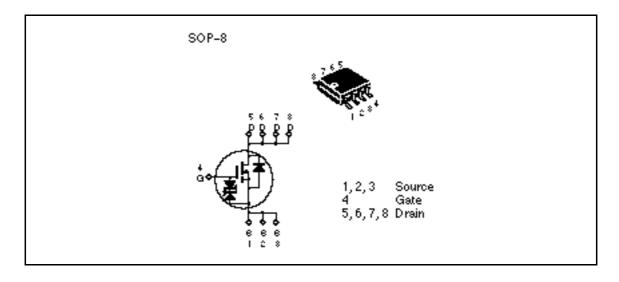
# HITACHI

ADE-208-523 B 3rd. Edition

#### **Features**

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

#### **Outline**





### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	20	V
Gate to source voltage	V <sub>GSS</sub>	±12	V
Drain current	I <sub>D</sub>	11	A
Drain peak current	I <sub>D(pulse)</sub> *1	88	A
Body to drain diode reverse drain current	I <sub>DR</sub>	11	A
Channel dissipation	Pch*2	2.5	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW 10 µs, duty cycle 1 %

2. When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW 10s

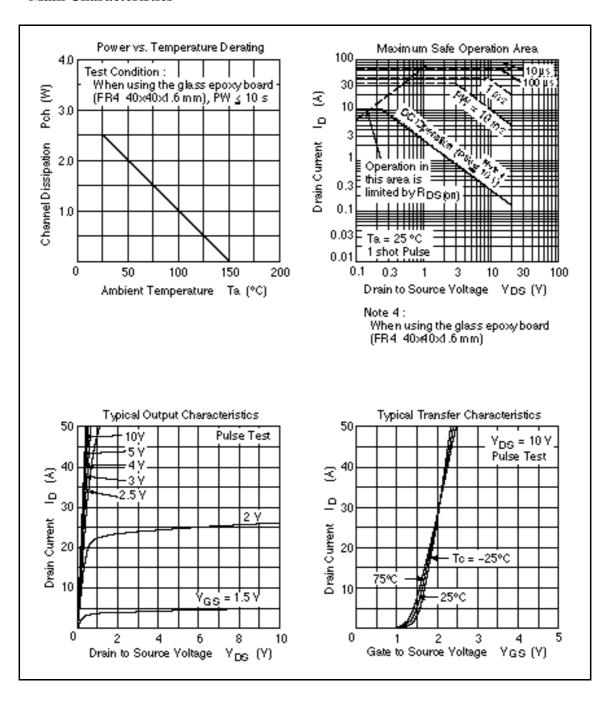
#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

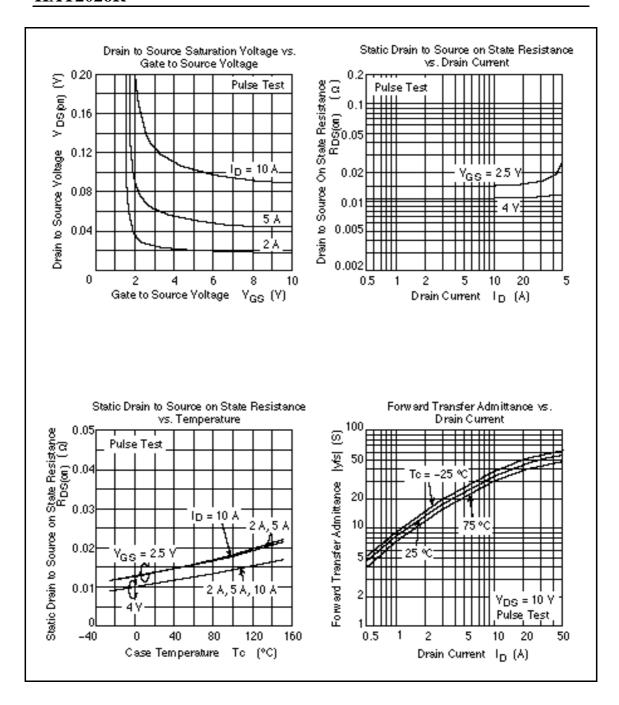
Item	Symbol	Min	Тур	Max	Unit	<b>Test Conditions</b>
Drain to source breakdown voltage	$V_{(BR)DSS}$	20	_	_	V	$I_D = 10$ mA, $V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±12	_	_	V	$I_{G} = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	I <sub>GSS</sub>	_	_	±10	μΑ	$V_{GS} = \pm 10V, V_{DS} = 0$
Zero gate voltege drain current	I <sub>DSS</sub>	_	_	1	μΑ	$V_{DS} = 20 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{\rm GS(off)}$	0.4	_	1.4	V	$V_{DS} = 10V$ , $I_D = 1mA$
Static drain to source on state	$R_{\text{DS(on)}}$	_	0.011	0.015		$I_D = 6A, V_{GS} = 4V^{*1}$
resistance	$R_{DS(on)}$	_	0.014	0.021		$I_D = 6A, V_{GS} = 2.5V^{*1}$
Forward transfer admittance	y <sub>fs</sub>	18	27	_	S	$I_D = 6A, V_{DS} = 10V^{*1}$
Input capacitance	Ciss	_	1760	_	pF	V <sub>DS</sub> = 10V
Output capacitance	Coss	_	1130	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	450	_	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	_	35	_	ns	$V_{GS} = 4V$ , $I_D = 6A$
Rise time	t <sub>r</sub>	_	275	_	ns	V <sub>DD</sub> 10V
Turn-off delay time	$t_{d(off)}$	_	300	_	ns	_
Fall time	t <sub>f</sub>	_	340	_	ns	_
Body to drain diode forward voltage	$V_{DF}$	_	0.83	1.08	V	$IF = 11A, V_{GS} = 0^{*1}$
Body to drain diode reverse recovery time	t <sub>rr</sub>	_	75	_	ns	IF = 11A, $V_{GS} = 0$ diF/ dt =20A/ $\mu$ s

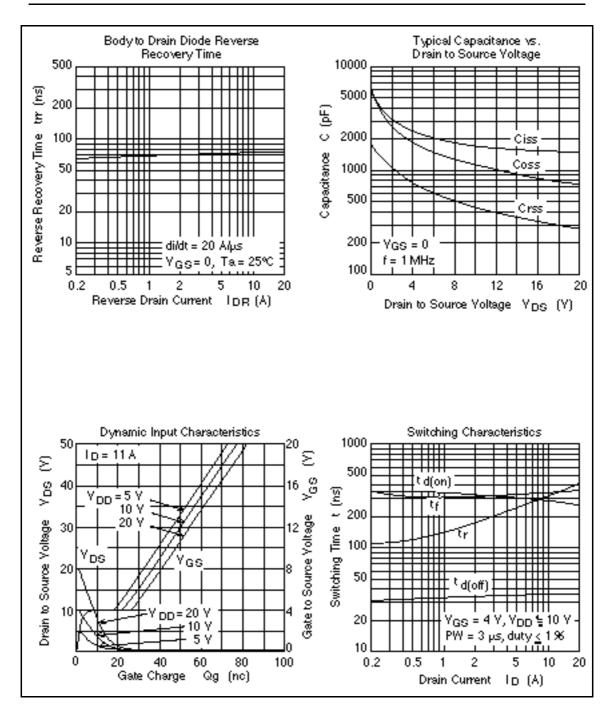
Note: 1. Pulse test

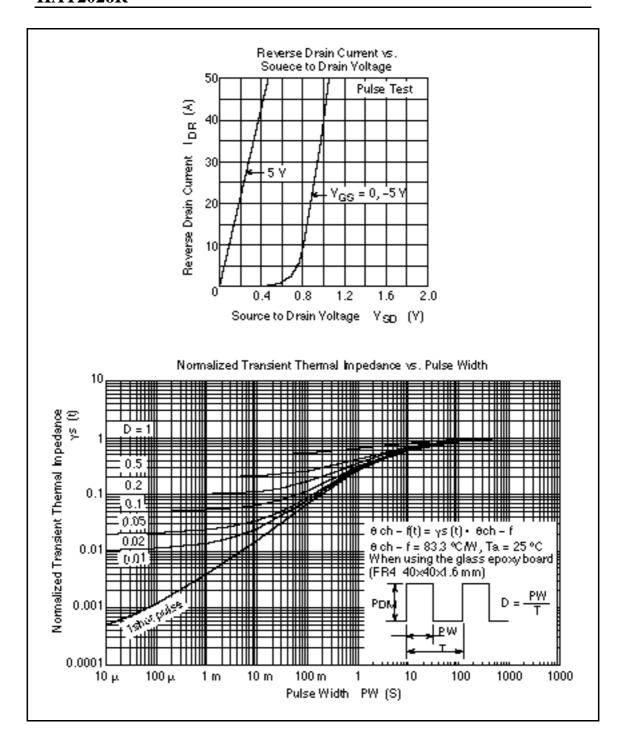
The specifications may be change without notice.

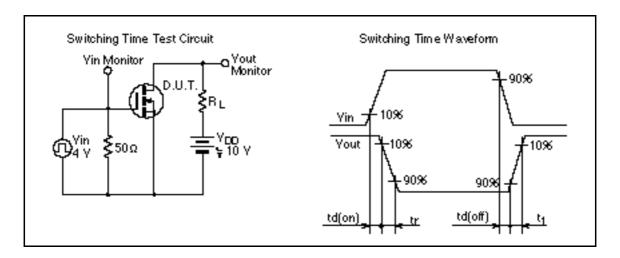
#### **Main Characteristics**





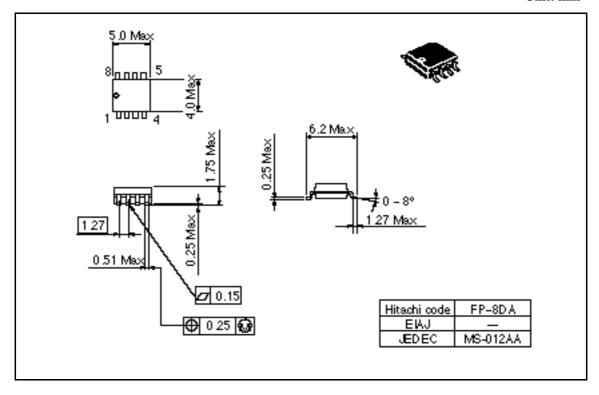






#### **Package Dimensions**

Unit: mm



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